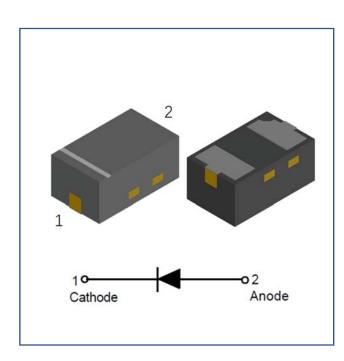


## **Small Signal Schottky Diode**



#### **Features**

• Moisture sensitivity level 3

• Reverse voltage: 40V

Average forward current: 200mA

### **Application**

High frequency and low voltage rectifier

#### **Mechanical data**

• Package: DFN1006-2L

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

## ■ Maximum Ratings (Ta=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Value
Device marking code			Т
Repetitive peak reverse voltage	$V_{RRM}$	V	40
Forward current	l <sub>F</sub>	mA	200
Non-repetitive surge peak forward current @ t=8.3ms half-sine wave			0.5
Non-repetitive surge peak forward current @ t=1ms square wave	I <sub>FSM</sub>	A	1
Power dissipation	$P_{D}$	mW	100
Junction temperature	TJ	°C	-55 to +125
Storage temperature	$T_{STG}$	℃	-55 to +125



## ■ Electrical Characteristics (T<sub>a</sub>=25°C Unless otherwise specified)

Parameter	Symbol	Unit	Conditions	Min	Тур	Max
Reverse voltage	$V_{R}$	٧	I <sub>R</sub> =100uA	40		
Forward voltage	V <sub>F</sub>	٧	I <sub>F</sub> =200mA			0.59
Reverse leakage current	I <sub>R</sub>	uA	V <sub>R</sub> =30V			5

#### **■ Thermal Characteristics**

Parameter	Symbol	Unit	Value
Thermal resistance, junction-to-ambient	R <sub>0</sub> J-A <sup>(1)</sup>	°C/W	1000
Thermal resistance, junction-to-case	RθJ-C <sup>(1)</sup>	°C/W	800

#### Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 1.7cm\*1cm copper pad areas;



#### **■**Characteristics

Fig 1: P<sub>D</sub>-Ta Curve

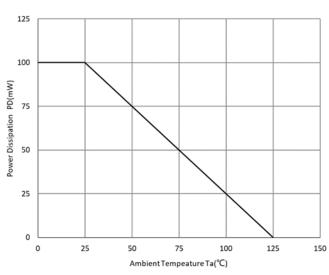


Fig 3: Typical Forward Characteristics

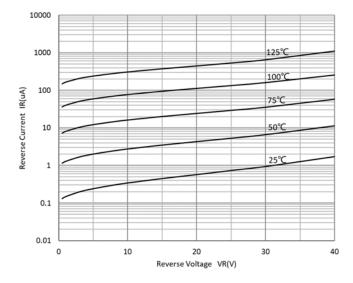


Fig 2: Capacitance Capability

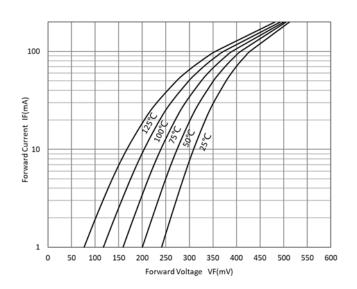
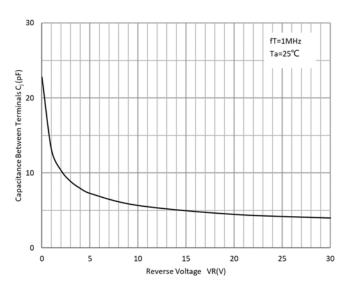


Fig 4: Typical Reverse Characteristics

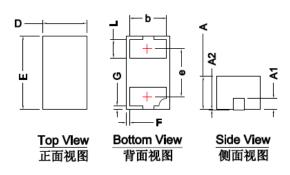




## **■**Ordering Information

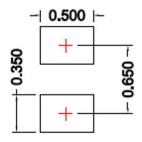
Prefered P/N	Packing Code	Unit Weight(g)	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
RB521S-40L2	F1	Approximate 0.9	10000	100000	400000	Tape & Reel

#### **■ Outline Dimensions**



SYMBOL	MILLIMETER				
STIVIDOL	MIN	NOM	MAX		
D	0.50	0.60	0.70		
Е	0.90	1.00	1.10		
Α	0.35	0.45	0.55		
A1	0.15 BSC				
A2			0.10		
F	0.005				
G	0.005				
L	0.15	0.25	0.35		
b	0.41	0.50	0.59		
е	0.65 BSC				

### ■ Suggested Pad Layout





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